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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jiang et al.
Serial No.: 09/966,605
Filing Date: 09/28/2001
Customer No.: 23494

Art Unit: 1765
Examiner: Vinh, Lan
Docket No.: TI-31462
Conf. No.: 4769

Title: IN-SITU PLASMA ASH/TREATMENT AFTER VIA ETCH OF LOW-K FILMS FOR POISON-FREE DUAL DAMASCENE TRENCH PATTERNING

AMENDMENT AFTER FINAL

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at (703) 872 - 9306 on 4/19/2004.

Jacqueline J. Garner
Reg. No. 36,144

Dear Sir:

The following amendments and remarks are offered in response to the Examiner's Office Action dated 11/18/2003. They are respectfully submitted as a full and complete response to that Action.

Please amend the above-referenced application as follows:

There are no **Amendments to the Specification**.

Amendments to the Claims are reflected in the listing of claims that begin on page 2 of this paper.

There are no **Amendments to the Drawings**.

The **Remarks** begin on page 5.

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